



# BTRSA28A401

## 400W Surface Mount Transient Voltage Suppressor

### FEATURES

- 400W Peak Pulse Power dissipation at 10/1000 $\mu$ s waveform ,  
Repetition rate (duty cycle): 0.01%
- 28V Stand-off Voltage
- Glass passivated junction
- Uni-Directional versions available
- Low leakage
- Low inductance
- Very Fast Response Time
- Excellent clamping capability
- Plastic package is flammability rated 94V-0  
Underwriters Laboratories
- Halogen free and ROHS compliant



### MECHANICAL DATA

- Package : SMA/DO-214AC
- Case Material: Green Molding Compound
- Terminals: Meets MSL level 1 , per J-STD-020 , maximum peak of 260 $^{\circ}$ C
- Polarity Indicator: Color band denotes cathode  
(Note: Bi-directional devices have no polarity indicator)

### APPLICATIONS

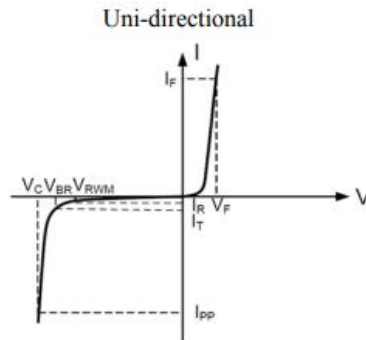
- AC/DC Power supply
- I/O Interface
- Low frequency signal transmission line  
(RS232, RS485, etc.)

### SCHEMATIC & PIN CONFIGURATION



Uni-directional

**ELECTRICAL PARAMETERS** (TA=25°C Unless otherwise noted)



Symbol	Parameter
Ipp	Maximum Reverse Peak Pulse Current
Vc	Clamping Voltage @ Ipp
VRWM	Working Peak Reverse Voltage
IR	Maximum Reverse Leakage Current @ VRWM
VBR	Breakdown Voltage @ IT
IT	Test Current
IF	Forward Current
VF	Forward Voltage @ IF

**ABSOLUTE MAXIMUM RATINGS** (TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Peak Pulse Power ( tp =10/1000µs ) (Note 1, 2)	PPP	400	W
Maximum Peak Pulse Current ( tp =10/1000µs ) (Note 1)	Ipp	8.8	A
Steady State Power Dissipation @ TA = 50°C (Note 2)	PM(AV)	3.3	W
Maximum Instantaneous Forward Voltage at 50A for Uni-directional Only	VF	3.5	V
Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load , JEDEC Method (Note 3)	IFSM	60	A
Operating Junction Temperature	TJ	-40 ~ 150	°C
Storage Temperature Range	TSTG	-40 ~ 150	°C
Junction to Ambient on Printed Circuit	RθJA	120	°C/W
Lead Soldering Temperature	TL	260 ( 10sec )	°C

- Note: 1. Non-repetitive current pulse, TA = 25°C .  
 2. Mounted on 5.0mm x 5.0mm Copper Pads to each terminal.  
 3. 8.3ms single half sine-wave, or equivalent square wave, Duty cycle=4 pulses per minutes maximum.

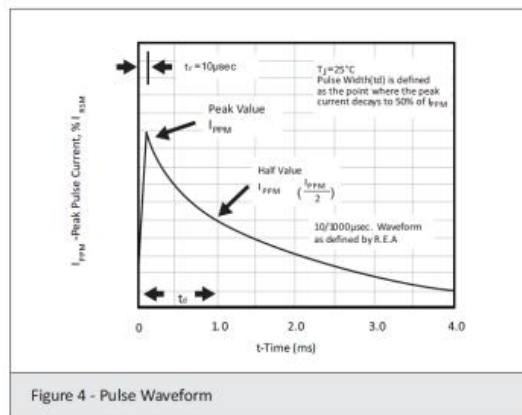
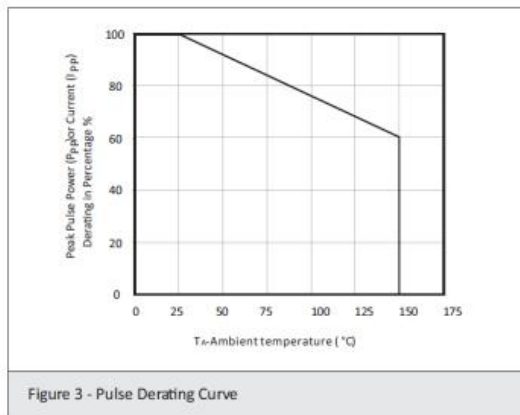
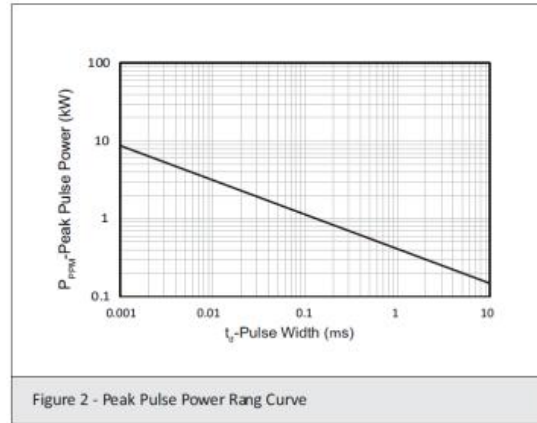
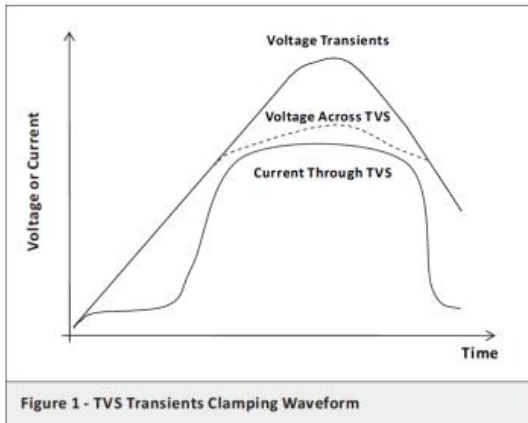


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## ELECTRICAL CHARACTERISTICS

Part Number	Reverse Stand off Voltage	Break down Voltage $V_{BR}$ @ $I_T$		Test Current	Max. Reverse Leakage @ $V_{RWM}$	Max. Clamping Voltage @ $I_{pp}$	Max. Peak Pulse Current
	$V_{RWM}$ (V)	Min (V)	Max (V)	$I_T$ (mA)	$I_R$ ( $\mu$ A)	$V_C$ (V)	$I_{pp}$ (A)
BTRSA28A401	28	31.1	34.4	1	1	45.4	8.8

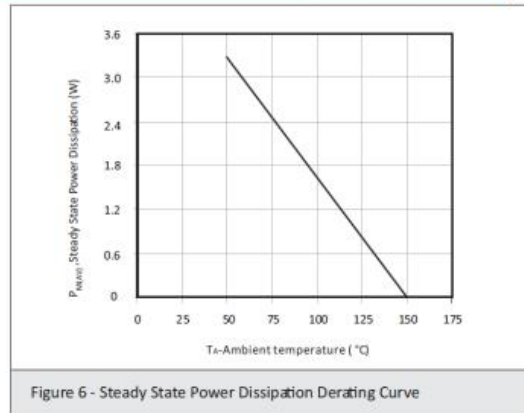
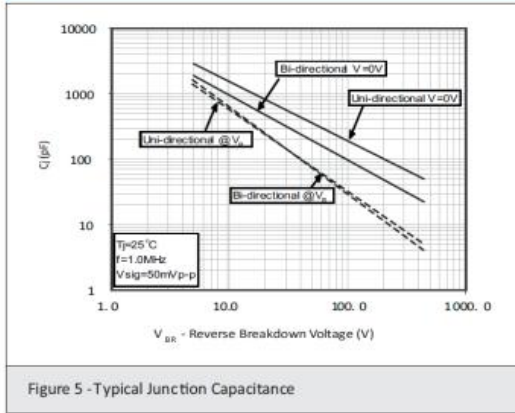
## TYPICAL CHARACTERISTICS





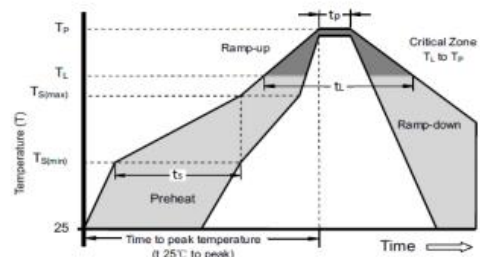
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### SOLDERING PARAMETERS

Reflow Condition		Lead-free assembly
Pre Heat	Temperature Min (Ts(min))	150°C
	Temperature Max (Ts(max))	200°C
	Time (min to max) (ts)	60 – 180 secs
Average ramp up rate (Liquidus Temp (TL) to peak)		3°C/second max
Ts(max) to TL - Ramp-up Rate		3°C/second max
Reflow	Temperature (Tj) (Liquidus)	217°C
	Time (min to max) (ts)	60 – 150 seconds
Peak Temperature (Tp)		260°C
Time within 5°C of actual peak Temperature (tp)		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (Tp)		8 minutes Max.
Do not exceed		260°C

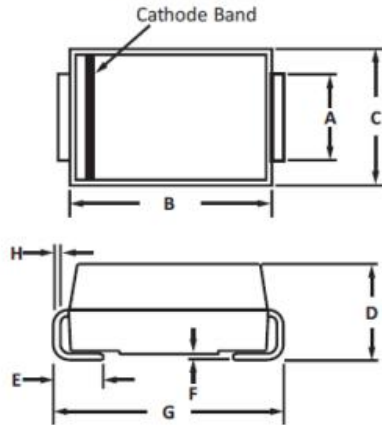




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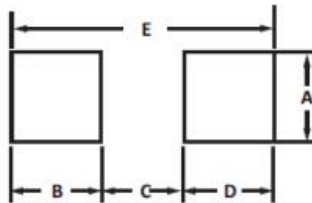
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### PACKAGE OUTLINE



DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.
A	0.048	0.064	1.23	1.63
B	0.161	0.179	4.10	4.55
C	0.102	0.110	2.60	2.80
D	0.085	0.093	2.15	2.35
E	0.030	0.059	0.75	1.51
F	0.001	0.008	0.02	0.20
G	0.192	0.206	4.87	5.22
H	0.006	0.012	0.15	0.30

### RECOMMENDED PAD LAYOUT DIMENSIONS



DIM	Inches	Millimeters
A	0.064	1.63
B	0.057	1.45
C	0.090	2.28
D	0.057	1.45
E	0.208 Ref.	5.28 Ref.

### ORDERING INFORMATION

Chip Size	Parts on 13 inch (330mm) Reel
DO-214AC	5,000 PCS